

The 32nd International Horticultural Congress

Kyoto International Conference Center, Kyoto JAPAN



August 23rd (SUN) to 28th (FRI), 2026
<https://www.ihc2026.org/>

The 32nd International Horticultural Congress will serve as a platform for sharing knowledge and technologies related to the diverse range of horticultural plants, production, and utilization worldwide. The IHC is the world's largest event dedicated to horticultural science.

Over six days in August 2026, more than 2,500 international participants from 80 countries will gather in Kyoto. As a sponsor, you can showcase your products and services to an audience of academic professionals, researchers, producers, market stakeholders, and service providers. The congress offers an exceptional opportunity to highlight your contributions and innovations in promoting sustainable health, welfare, and production systems in the horticulture and food industries. We invite you to apply for sponsorship as outlined in the prospectus and take advantage of the sponsorship benefits.

The congress will feature 27 symposiums, and sponsorship opportunities for each symposium are also available. The benefits of becoming a symposium sponsor vary depending on the sponsorship amount as listed below.

Symposium Sponsorship Type	Symposium Bronze	Symposium Silver	Symposium Gold	Symposium Platinum	Symposium Diamond
Fee (JPY)	150,000	300,000	500,000	1,000,000	2,000,000
Logo on symposium and program page of the IHC2026 website	✓	✓	✓	✓	✓
Thanks at the symposium room convener	✓	✓	✓	✓	✓
Logo on the screen of the symposium room	✓	✓	✓	✓	✓
Space for distribution of goods/flyers at the entrance to the symposium room	✓	✓	✓	✓	✓
Logo in the program booklet (at the symposium title page)		✓	✓	✓	✓
Advertisement program booklet (Inside a quarter page, color/black and white)			✓	✓	
Advertisement program booklet (Inside a full page, color/black and white)					✓
Exhibition booth (6 sqm)				✓	
Exhibition booth (9 sqm)					✓
Registration pass					1

< Contact Information >

■ IHC2026 Management Office

Keihanshin Yodoyabashi Building 2F 4-4-7 Imabashi, Chuo-ku, Osaka, 541-0042, Japan

E-Mail: sp-ihc2026@convention.co.jp

Application Form

<https://www.ihc2026.org/call-for-symposium-sponsors/>

Application Deadline: November 15th, 2025 → April 30th, 2026